

Surface Mount Schottky Barrier Rectifier
Reverse Voltage - 20 to 200 V
Forward Current - 1.0 A

SS12F ---SS120F

FEATURES

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View
 Marking Code: SS12 — SS120
 Simplified outline SMAF and symbol

Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SS12F	SS14F	SS16F	SS18F	SS110F	SS112F	SS115F	SS120F	Units				
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V				
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V				
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V				
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1.0							A					
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	40				30				A				
Max Instantaneous Forward Voltage at 1 A	V_F	0.55		0.70		0.85		0.90		V				
Maximum DC Reverse Current $T_a = 25^\circ C$ at Rated DC Reverse Voltage $T_a = 100^\circ C$	I_R	0.3 10			0.2 5		0.1 2		mA					
Typical Junction Capacitance ¹⁾	C_j	110		80						pF				
Typical Thermal Resistance ²⁾	$R_{\theta JA}$	95							$^\circ C/W$					
Operating Junction Temperature Range	T_j	-55 ~ +125							$^\circ C$					
Storage Temperature Range	T_{stg}	-55 ~ +150							$^\circ C$					

1) Measured at 1MHz and applied reverse voltage of 4 V D.C.

2) P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

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Fig.1 Forward Current Derating Curve

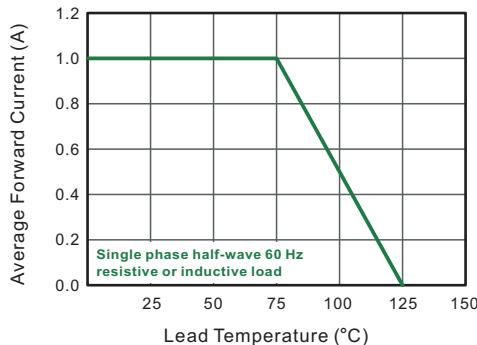


Fig.2 Typical Reverse Characteristics

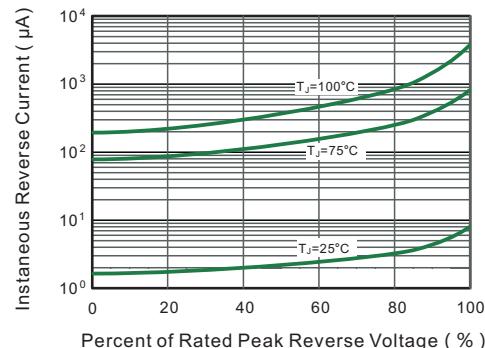


Fig.3 Typical Forward Characteristic

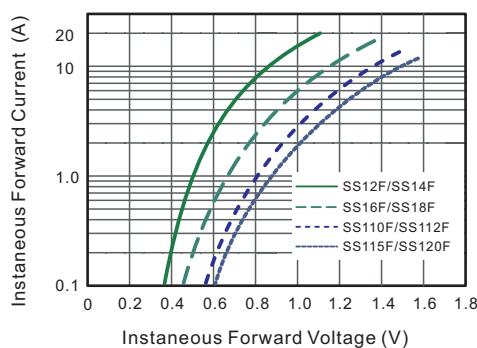


Fig.4 Typical Junction Capacitance

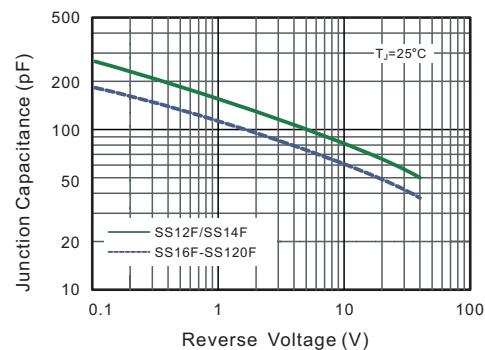


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

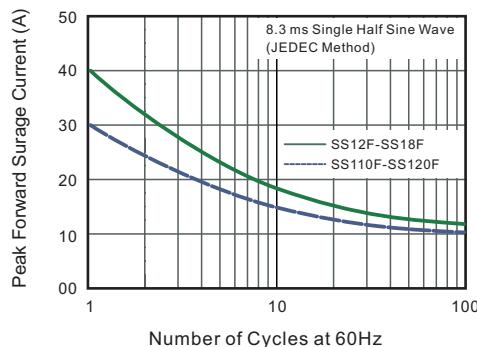


Fig.6-Typical Transient Thermal Impedance

